

SEMICONDUCTOR TM

NDS9430A Single P-Channel Enhancement Mode Field Effect Transistor

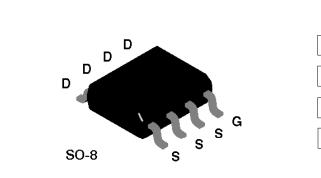
General Description

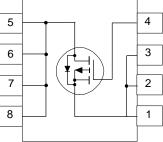
These P-Channel enhancement mode power field effect transistors are produced using National's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulses in the avalanche and commutation modes. These devices are particularly suited for low voltage applications such as notebook computer power management and other battery powered circuits where fast switching, low in-line power loss, and resistance to transients are needed.

Features

- $\label{eq:constraint} \begin{array}{l} \bullet & -5.3A, \ -20V. \ R_{\text{DS}(\text{ON})} = 0.05\Omega \ @ \ V_{\text{GS}} = -10V \\ R_{\text{DS}(\text{ON})} = 0.065\Omega \ @ \ V_{\text{GS}} = -6V \\ R_{\text{DS}(\text{ON})} = 0.09\Omega \ @ \ V_{\text{GS}} = -4.5V. \end{array}$
- High density cell design for extremely low R_{DS(ON)}.
- High power and current handling capability in a widely used surface mount package.

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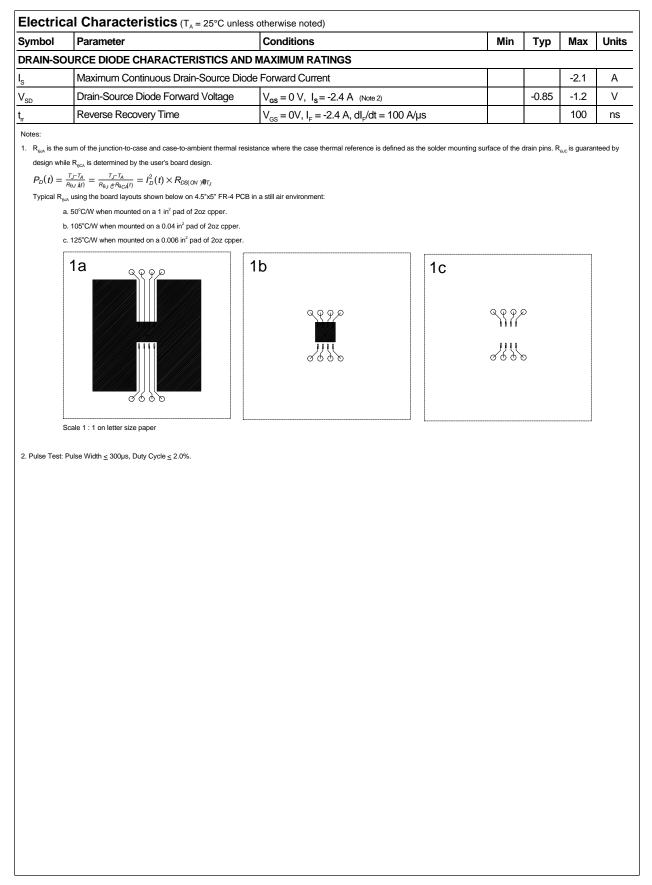


Absolute Maximum Ratings T_a = 25°C unless otherwise noted

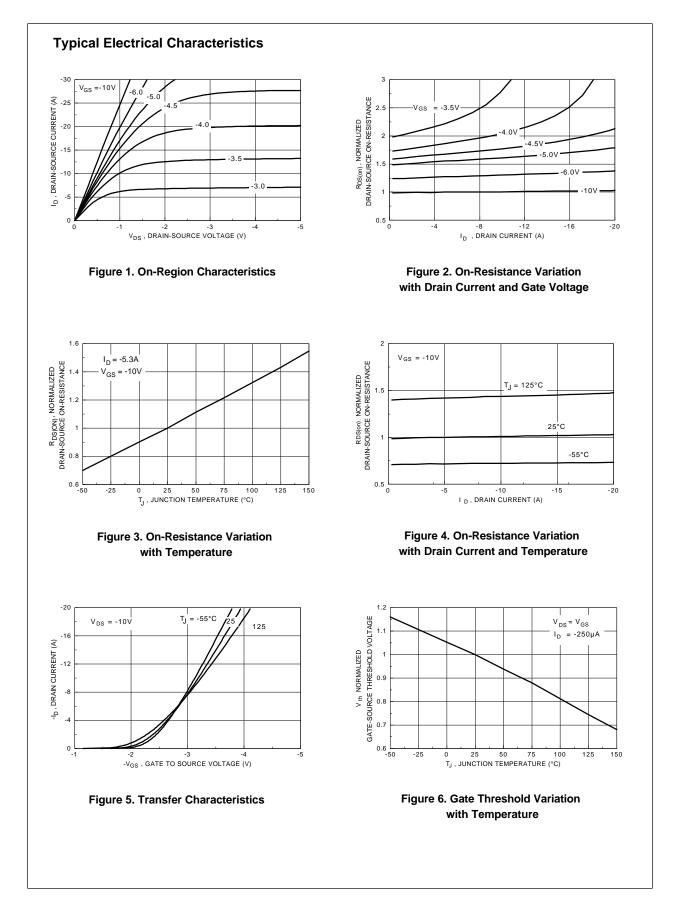
| Symbol | Parameter | | NDS9430A | Units | |
|----------------------|---|------------------|------------|-------|--|
| V _{DSS} | Drain-Source Voltage | | -20 | V | |
| V _{GSS} | Gate-Source Voltage | | ±20 | V | |
| l _D | Drain Current - Continuous | (Note 1a) | ± 5.3 | A | |
| | - Pulsed | | ±20 | | |
| P _D | Maximum Power Dissipation | (Note 1a) | 2.5 | W | |
| | | (Note 1b) | 1.2 | | |
| | | (Note 1c) | 1 | | |
| T_J,T _{STG} | Operating and Storage Temperature Range | | -55 to 150 | C° | |
| THERMA | L CHARACTERISTICS | | | | |
| R _{θJA} | Thermal Resistance, Junction-to-Am | ibient (Note 1a) | 50 | °C/W | |
| R _{θJC} | Thermal Resistance, Junction-to-Ca | Se (Note 1) | 25 | °C/W | |

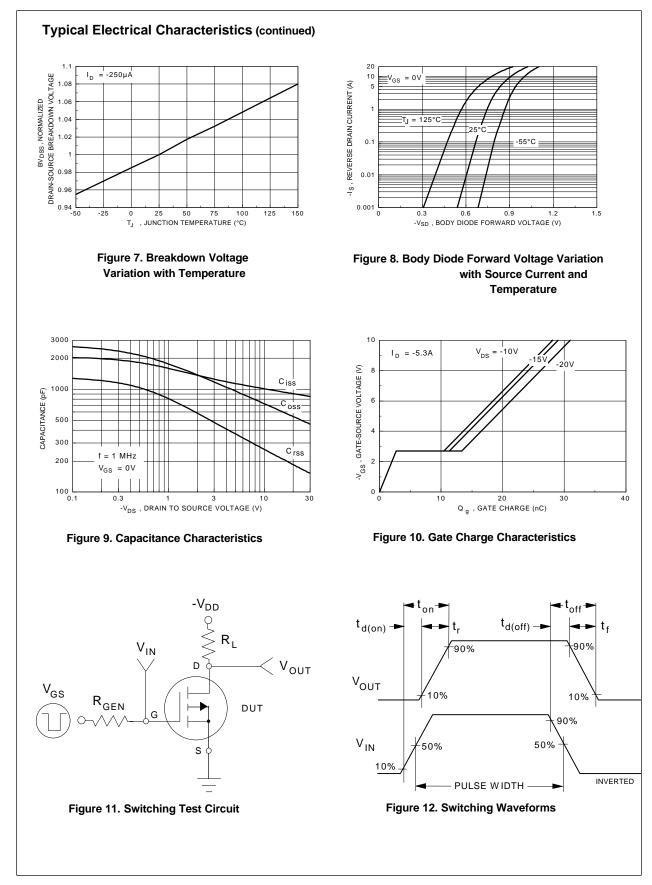
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| Symbol | Parameter | Conditions | | Min | Тур | Max | Units |
|---------------------|-----------------------------------|--|------------------------|------|-------|-------|-------|
| OFF CHA | RACTERISTICS | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | $V_{gg} = 0 \text{ V}, \text{ I}_{p} = -250 \mu\text{A}$ | | -20 | | | V |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = -16 V, V_{GS} = 0 V$ | | | | -1 | μA |
| | | $V_{\rm DS} = -10 \text{ V}, V_{\rm GS} = 0 \text{ V}$ | $T_J = 70^{\circ}C$ | | | -5 | μA |
| | Gate - Body Leakage, Forward | $V_{gg} = 20 \text{ V}, V_{Dg} = 0 \text{ V}$ | | | | 100 | nA |
| I _{GSSR} | Gate - Body Leakage, Reverse | V _{GS} = -20 V, V _{DS} = 0 V | | | | -100 | nA |
| ON CHAR | ACTERISTICS (Note 2) | | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | $V_{ps} = V_{qs}, I_{p} = -250 \mu\text{A}$ | | -1 | -1.4 | -3 | V |
| | | | T _J = 125°C | -0.7 | -1 | -2 | |
| R _{DS(ON)} | Static Drain-Source On-Resistance | V _{gs} = -10 V, I _p = -5.3 A | | | 0.038 | 0.05 | Ω |
| | | | T _J = 125°C | | 0.054 | 0.1 | |
| | | $V_{gs} = -6 V, I_{p} = -4.7 A$ | | | 0.046 | 0.065 | |
| | | $V_{gs} = -4.5 \text{ V}, I_{p} = -4.2 \text{ A}$ | | | 0.064 | 0.09 | |
| I _{D(on)} | On-State Drain Current | $V_{GS} = -10 \text{ V}, \text{ V}_{DS} = -5 \text{ V}$ | | -15 | | | А |
| . , | | $V_{GS} = -4.5, V_{DS} = -5V$ | | -3.6 | | | |
| 9 _{FS} | Forward Transconductance | $V_{\rm DS} = 15 \text{ V}, \text{ I}_{\rm D} = 5.3 \text{ A}$ | | | 10 | | S |
| DYNAMIC | CHARACTERISTICS | | | | | | |
| C _{iss} | Input Capacitance | $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz | | | 950 | | pF |
| C _{oss} | Output Capacitance | | | | 610 | | pF |
| C _{rss} | Reverse Transfer Capacitance | | | | 220 | | pF |
| SWITCHIN | IG CHARACTERISTICS (Note 2) | | | | | | |
| t _{D(on)} | Tum - On Delay Time | $V_{DD} = -10 \text{ V}, I_{D} = -1 \text{ A},$ | | | 10 | 30 | ns |
| t, | Turn - On Rise Time | V_{gen} = -10 V, R_{gen} = 6 Ω | | | 18 | 60 | ns |
| t _{D(off)} | Turn - Off Delay Time | | | | 80 | 120 | ns |
| t, | Turn - Off Fall Time | | | | 45 | 100 | ns |
| Q _g | Total Gate Charge | $V_{DS} = -10 V,$ $I_{D} = -5.3 A, V_{GS} = -10 V$ | | | 29 | 50 | nC |
| Q _{gs} | Gate-Source Charge | $I_{\rm D} = -5.3 \text{ A}, V_{\rm GS} = -10 \text{ V}$ | | | 3 | | nC |
| Q _{gd} | Gate-Drain Charge | | | | 9 | | nC |

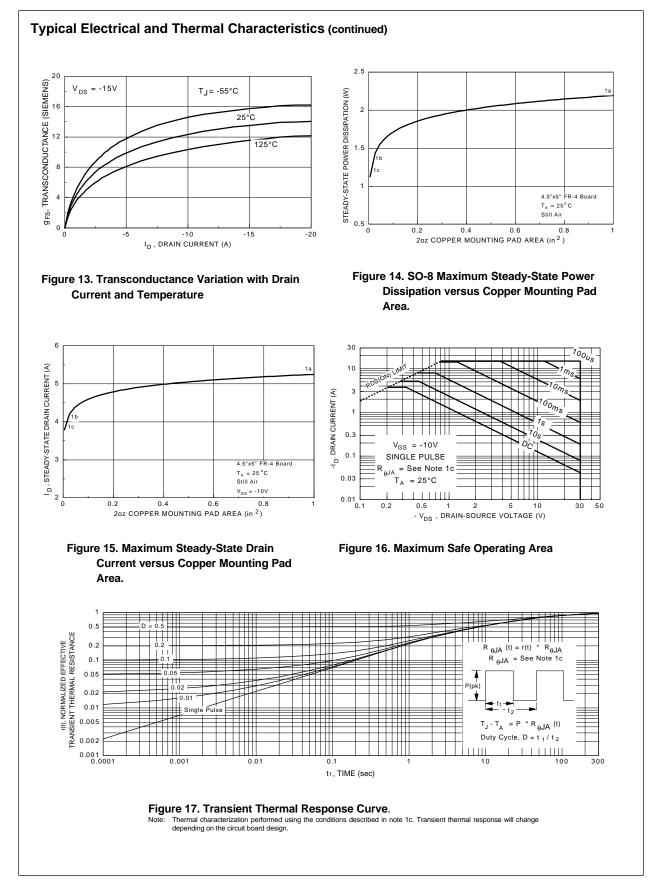


NDS9430A Rev.A





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